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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	18
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1708-e-p

PIC16(L)F1704/8

TABLE 1-3: PIC16(L)F1708 PIN OUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/VREF-/C1IN+/DAC1OUT/ICSPDAT	RA0	TTL/ST	CMOS	General purpose I/O.
	AN0	AN	—	ADC Channel 0 input.
	VREF-	AN	—	ADC Negative Voltage Reference input.
	C1IN+	AN	—	Comparator C1 positive input.
	DAC1OUT	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RA1/AN1/VREF+/C1IN0-/C2IN0-/ICSPCLK	RA1	TTL/ST	CMOS	General purpose I/O.
	AN1	AN	—	ADC Channel 1 input.
	VREF+	AN	—	ADC Voltage Reference input.
	C1IN0-	AN	—	Comparator C2 negative input.
	C2IN0-	AN	—	Comparator C3 negative input.
	ICSPCLK	ST	—	Serial Programming Clock.
RA2/AN2/DAC1OUT2/ZCD/T0CKI ⁽¹⁾ /COGIN ⁽¹⁾ /INT ⁽¹⁾	RA2	TTL/ST	CMOS	General purpose I/O.
	AN2	AN	—	ADC Channel 2 input.
	DAC1OUT2	—	AN	Digital-to-Analog Converter output.
	ZCD	—	AN	Zero-Cross Detection Current Source/Sink.
	T0CKI	ST	—	Timer0 clock input.
	COGIN	ST	CMOS	Complementary Output Generator input.
RA3/MCLR/VPP	RA3	TTL/ST	CMOS	General purpose I/O.
	MCLR	ST	—	Master Clear with internal pull-up.
	VPP	HV	—	Programming voltage.
RA4/AN3/T1G ⁽¹⁾ /SOSCO/OSC2/CLKOUT	RA4	TTL/ST	CMOS	General purpose I/O.
	AN3	AN	—	ADC Channel 3 input.
	T1G	ST	—	Timer1 gate input.
	SOSCO	XTAL	XTAL	Secondary Oscillator Connection.
	OSC2	—	XTAL	Crystal/Resonator (LP, XT, HS modes).
	CLKOUT	—	CMOS	Fosc/4 output.
RA5/T1CKI/SOSCI/CLCIN3 ⁽¹⁾ /OSC1/CLKIN	RA5	TTL/ST	CMOS	General purpose I/O.
	T1CKI	ST	—	Timer1 clock input.
	SOSCI	XTAL	XTAL	Secondary Oscillator Connection.
	CLCIN3	ST	—	Configurable Logic Cell source input.
	OSC1	—	XTAL	Crystal/Resonator (LP, XT, HS modes).
	CLKIN	ST	—	External clock input (EC mode).
RB4/AN10/OPA1IN-/SCK ⁽¹⁾ /SDA ⁽³⁾	RB4	TTL/ST	CMOS	General purpose I/O.
	AN10	AN	—	ADC Channel 10 input.
	OPA1IN-	AN	—	Operational Amplifier 1 inverting input.
	SCK	ST	CMOS	SPI clock.
	SDA	I ² C	OD	I ² C data input/output.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I²C = Schmitt Trigger input with I²C
HV = High Voltage XTAL = Crystal levels

- Note** 1: Default peripheral input. Input can be moved to any other pin with the PPS input selection registers. See Register 12-2.
2: All pin outputs default to PORT latch data. Any pin can be selected as a digital peripheral output with the PPS output selection registers. See Register 12-3.
3: These I²C functions are bidirectional. The output pin selections must be the same as the input pin selections.

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3.3 Data Memory Organization

The data memory is partitioned in 32 memory banks with 128 bytes in a bank. Each bank consists of (Figure 3-2):

- 12 core registers
- 20 Special Function Registers (SFR)
- Up to 80 bytes of General Purpose RAM (GPR)
- 16 bytes of common RAM

The active bank is selected by writing the bank number into the Bank Select Register (BSR). Unimplemented memory will read as '0'. All data memory can be accessed either directly (via instructions that use the file registers) or indirectly via the two File Select Registers (FSR). See **Section 3.7 “Indirect Addressing”** for more information.

Data memory uses a 12-bit address. The upper five bits of the address define the Bank address and the lower seven bits select the registers/RAM in that bank.

3.3.1 CORE REGISTERS

The core registers contain the registers that directly affect the basic operation. The core registers occupy the first 12 addresses of every data memory bank (addresses x00h/x08h through x0Bh/x8Bh). These registers are listed below in Table 3-2. For detailed information, see Table 3-9.

TABLE 3-2: CORE REGISTERS

Addresses	BANKx
x00h or x80h	INDF0
x01h or x81h	INDF1
x02h or x82h	PCL
x03h or x83h	STATUS
x04h or x84h	FSR0L
x05h or x85h	FSR0H
x06h or x86h	FSR1L
x07h or x87h	FSR1H
x08h or x88h	BSR
x09h or x89h	WREG
x0Ah or x8Ah	PCLATH
x0Bh or x8Bh	INTCON

3.3.1.1 STATUS Register

The STATUS register, shown in Register 3-1, contains:

- the arithmetic status of the ALU
- the Reset status

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the \overline{TO} and \overline{PD} bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper three bits and set the Z bit. This leaves the STATUS register as '000u u1uu' (where u = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits (Refer to **Section 31.0 “Instruction Set Summary”**).

Note: The C and DC bits operate as Borrow and Digit Borrow out bits, respectively, in subtraction.

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TABLE 3-10: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 31											
F8Ch to FE3h	—	Unimplemented								—	—
FE4h	STATUS_SHAD	—	—	—	—	—	Z	DC	C	---- -xxx	---- -uuu
FE5h	WREG_SHAD	Working Register Shadow								xxxx xxxx	uuuu uuuu
FE6h	BSR_SHAD	—	—	—	Bank Select Register Shadow					---x xxxx	---u uuuu
FE7h	PCLATH_SHAD	—	Program Counter Latch High Register Shadow							-xxx xxxx	uuuu uuuu
FE8h	FSR0L_SHAD	Indirect Data Memory Address 0 Low Pointer Shadow								xxxx xxxx	uuuu uuuu
FE9h	FSR0H_SHAD	Indirect Data Memory Address 0 High Pointer Shadow								xxxx xxxx	uuuu uuuu
FEAh	FSR1L_SHAD	Indirect Data Memory Address 1 Low Pointer Shadow								xxxx xxxx	uuuu uuuu
FEBh	FSR1H_SHAD	Indirect Data Memory Address 1 High Pointer Shadow								xxxx xxxx	uuuu uuuu
FECh	—	Unimplemented								—	—
FEDh	STKPTR	—	—	—	Current Stack Pointer					---1 1111	---1 1111
FEFh	TOSL	Top of Stack Low byte								xxxx xxxx	uuuu uuuu
FEFh	TOSH	—	Top of Stack High byte							-xxx xxxx	-uuu uuuu

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as '0'.

- Note** 1: Unimplemented, read as '1'.
2: PIC16(L)F1704 only.
3: PIC16(L)F1708 only.
4: Unimplemented on PIC16LF1704/8.

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4.0 DEVICE CONFIGURATION

Device configuration consists of Configuration Words, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as Configuration Word 1 at 8007h and Configuration Word 2 at 8008h.

<p>Note: The $\overline{\text{DEBUG}}$ bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.</p>
--

TABLE 10-1: FLASH MEMORY ORGANIZATION BY DEVICE

Device	Row Erase (words)	Write Latches (words)
PIC16(L)F1704	32	32
PIC16(L)F1708		

10.2.1 READING THE FLASH PROGRAM MEMORY

To read a program memory location, the user must:

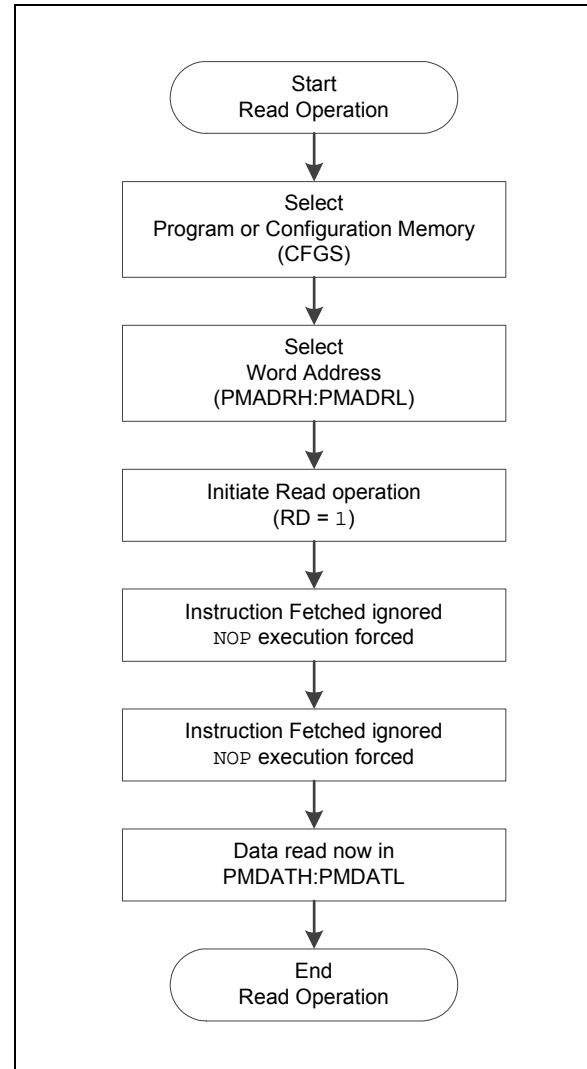
1. Write the desired address to the PMADRH:PMADRL register pair.
2. Clear the CFGS bit of the PMCON1 register.
3. Then, set control bit RD of the PMCON1 register.

Once the read control bit is set, the program memory Flash controller will use the second instruction cycle to read the data. This causes the second instruction immediately following the “BSF PMCON1, RD” instruction to be ignored. The data is available in the very next cycle, in the PMDATH:PMDATL register pair; therefore, it can be read as two bytes in the following instructions.

PMDATH:PMDATL register pair will hold this value until another read or until it is written to by the user.

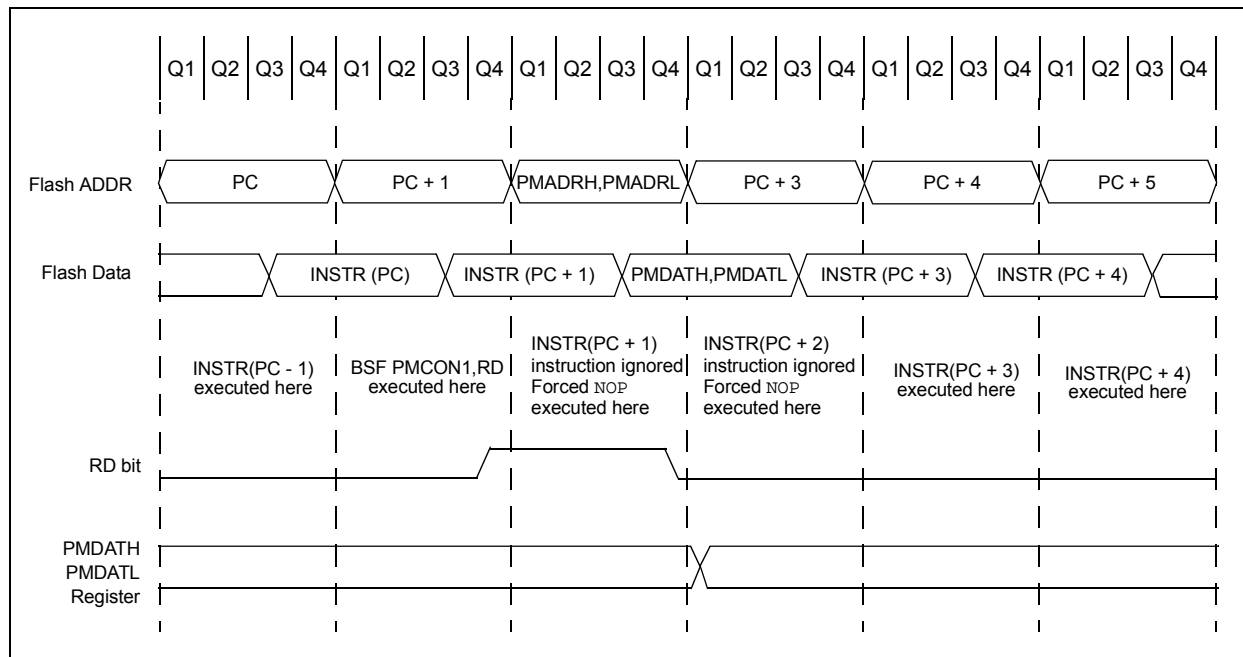
Note: The two instructions following a program memory read are required to be NOPs. This prevents the user from executing a 2-cycle instruction on the next instruction after the RD bit is set.

FIGURE 10-1: FLASH PROGRAM MEMORY READ FLOWCHART



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FIGURE 10-2: FLASH PROGRAM MEMORY READ CYCLE EXECUTION



EXAMPLE 10-1: FLASH PROGRAM MEMORY READ

```
* This code block will read 1 word of program
* memory at the memory address:
  PROG_ADDR_HI : PROG_ADDR_LO
* data will be returned in the variables;
* PROG_DATA_HI, PROG_DATA_LO

BANKSEL  PMADRL          ; Select Bank for PMCON registers
MOVLW    PROG_ADDR_LO    ;
MOVWF    PMADRL          ; Store LSB of address
MOVLW    PROG_ADDR_HI    ;
MOVWF    PMADRH          ; Store MSB of address

BCF       PMCON1,CFGSR    ; Do not select Configuration Space
BSF       PMCON1,RD       ; Initiate read
NOP       ; Ignored (Figure 10-1)
NOP       ; Ignored (Figure 10-1)

MOVF     PMDATL,W         ; Get LSB of word
MOVWF    PROG_DATA_LO    ; Store in user location
MOVF     PMDATH,W         ; Get MSB of word
MOVWF    PROG_DATA_HI    ; Store in user location
```

12.3 Bidirectional Pins

PPS selections for peripherals with bidirectional signals on a single pin must be made so that the PPS input and PPS output select the same pin. Peripherals that have bidirectional signals include:

- EUSART (synchronous operation)
- MSSP (I²C)

Note: The I²C default input pins are I²C and SMBus compatible and are the only pins on the device with this compatibility.

12.4 PPS Lock

The PPS includes a mode in which all input and output selections can be locked to prevent inadvertent changes. PPS selections are locked by setting the PPSLOCKED bit of the PPSLOCK register. Setting and clearing this bit requires a special sequence as an extra precaution against inadvertent changes. Examples of setting and clearing the PPSLOCKED bit are shown in Example 12-1.

EXAMPLE 12-1: PPS LOCK/UNLOCK SEQUENCE

```
; suspend interrupts
    bcf    INTCON,GIE
;   BANKSEL PPSLOCK      ; set bank
; required sequence, next 5 instructions
    movlw  0x55
    movwf  PPSLOCK
    movlw  0xAA
    movwf  PPSLOCK
; Set PPSLOCKED bit to disable writes or
; Clear PPSLOCKED bit to enable writes
    bsf    PPSLOCK,PPSLOCKED
; restore interrupts
    bsf    INTCON,GIE
```

12.5 PPS Permanent Lock

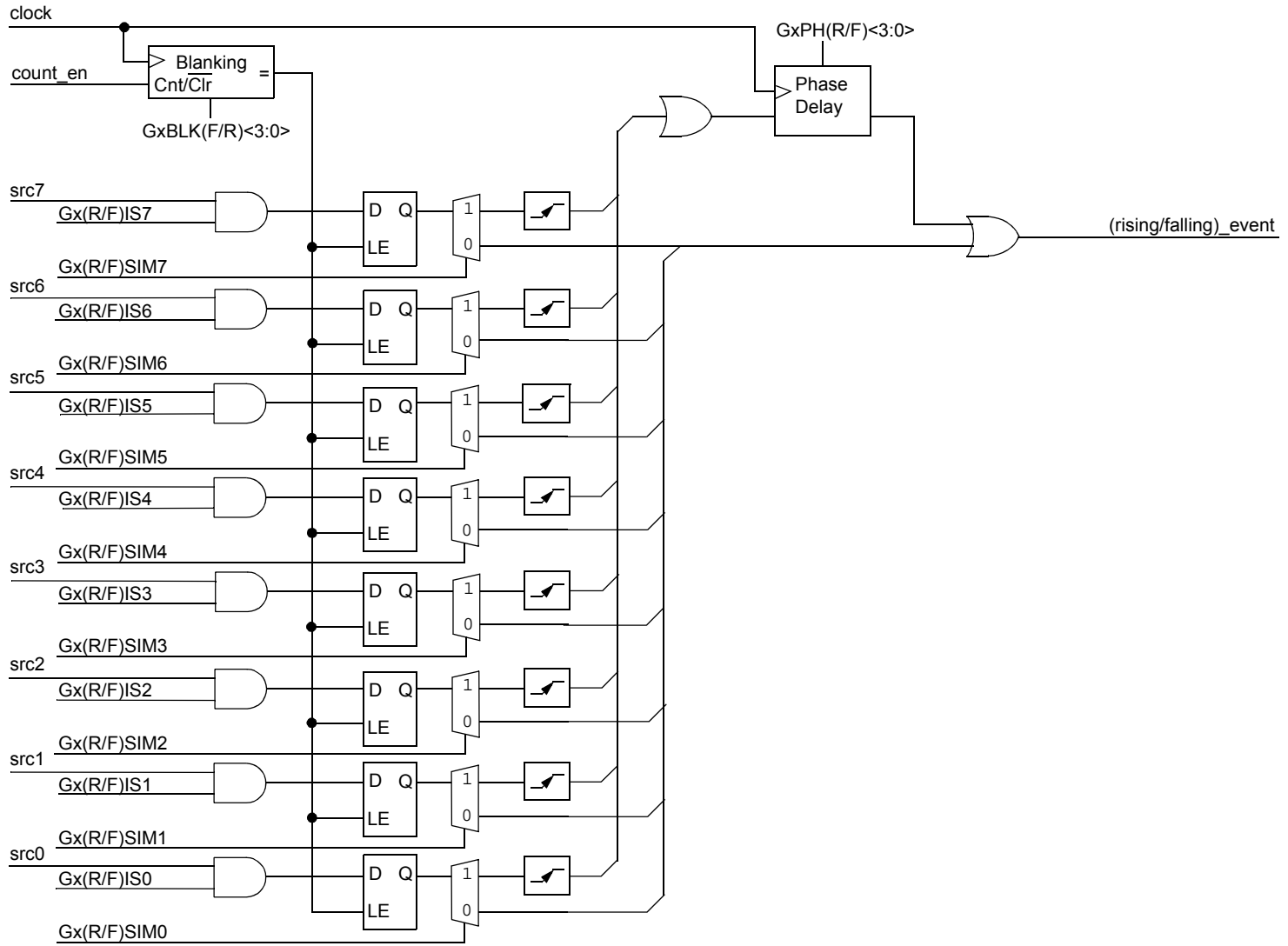
The PPS can be permanently locked by setting the PPS1WAY Configuration bit. When this bit is set, the PPSLOCKED bit can only be cleared and set one time after a device Reset. This allows for clearing the PPSLOCKED bit so that the input and output selections can be made during initialization. When the PPSLOCKED bit is set after all selections have been made, it will remain set and cannot be cleared until after the next device Reset event.

12.6 Operation During Sleep

PPS input and output selections are unaffected by Sleep.

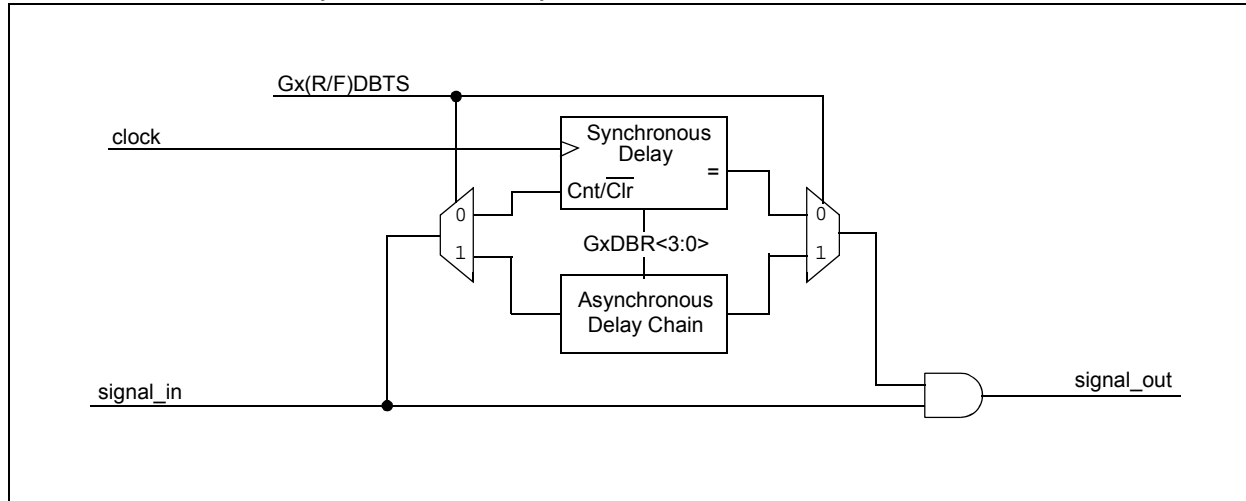
12.7 Effects of a Reset

A device Power-On-Reset (POR) clears all PPS input and output selections to their default values. All other Resets leave the selections unchanged. Default input selections are shown in pin allocation Table 1 and Table 2.

FIGURE 18-7: COG (RISING/FALLING) INPUT BLOCK

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FIGURE 18-8: COG (RISING/FALLING) DEAD-BAND BLOCK



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REGISTER 19-10: CLCxGLS3: GATE 4 LOGIC SELECT REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxG4D4T	LCxG4D4N	LCxG4D3T	LCxG4D3N	LCxG4D2T	LCxG4D2N	LCxG4D1T	LCxG4D1N
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7 **LCxG4D4T:** Gate 4 Data 4 True (non-inverted) bit

1 = lcxg4T is gated into lcxg4

0 = lcxg4T is not gated into lcxg4

bit 6 **LCxG4D4N:** Gate 4 Data 4 Negated (inverted) bit

1 = lcxg4N is gated into lcxg4

0 = lcxg4N is not gated into lcxg4

bit 5 **LCxG4D3T:** Gate 4 Data 3 True (non-inverted) bit

1 = lcxg3T is gated into lcxg4

0 = lcxg3T is not gated into lcxg4

bit 4 **LCxG4D3N:** Gate 4 Data 3 Negated (inverted) bit

1 = lcxg3N is gated into lcxg4

0 = lcxg3N is not gated into lcxg4

bit 3 **LCxG4D2T:** Gate 4 Data 2 True (non-inverted) bit

1 = lcxg2T is gated into lcxg4

0 = lcxg2T is not gated into lcxg4

bit 2 **LCxG4D2N:** Gate 4 Data 2 Negated (inverted) bit

1 = lcxg2N is gated into lcxg4

0 = lcxg2N is not gated into lcxg4

bit 1 **LCxG4D1T:** Gate 4 Data 1 True (non-inverted) bit

1 = lcxg1T is gated into lcxg4

0 = lcxg1T is not gated into lcxg4

bit 0 **LCxG4D1N:** Gate 4 Data 1 Negated (inverted) bit

1 = lcxg1N is gated into lcxg4

0 = lcxg1N is not gated into lcxg4

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCPx pin is set. (Exception: If the PWM duty cycle = 0%, the pin will not be set.)
- The PWM duty cycle is latched from CCPRxL into CCPRxH.

Note: The Timer postscaler (see **Section 26.1 “Timer2 Operation”**) is not used in the determination of the PWM frequency.

27.3.5 PWM DUTY CYCLE

The PWM duty cycle is specified by writing a 10-bit value to multiple registers: CCPRxL register and DCxB<1:0> bits of the CCPxCON register. The CCPRxL contains the eight MSBs and the DCxB<1:0> bits of the CCPxCON register contain the two LSBs. CCPRxL and DCxB<1:0> bits of the CCPxCON register can be written to at any time. The duty cycle value is not latched into CCPRxH until after the period completes (i.e., a match between PR2 and TMR2 registers occurs). While using the PWM, the CCPRxH register is read-only.

Equation 27-2 is used to calculate the PWM pulse width.

Equation 27-3 is used to calculate the PWM duty cycle ratio.

EQUATION 27-2: PULSE WIDTH

$$\text{Pulse Width} = (\text{CCPRxL:CCPxCON}<5:4>) \cdot T_{OSC} \cdot (\text{TMR2 Prescale Value})$$

EQUATION 27-3: DUTY CYCLE RATIO

$$\text{Duty Cycle Ratio} = \frac{(\text{CCPRxL:CCPxCON}<5:4>)}{4(\text{PR2} + 1)}$$

The CCPRxH register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

The 8-bit timer TMR2 register is concatenated with either the 2-bit internal system clock (FOSC), or two bits of the prescaler, to create the 10-bit time base. The system clock is used if the Timer2 prescaler is set to 1:1.

When the 10-bit time base matches the CCPRxH and 2-bit latch, then the CCPx pin is cleared (see Figure 27-4).

27.3.6 PWM RESOLUTION

The resolution determines the number of available duty cycles for a given period. For example, a 10-bit resolution will result in 1024 discrete duty cycles, whereas an 8-bit resolution will result in 256 discrete duty cycles.

The maximum PWM resolution is ten bits when PR2 is 255. The resolution is a function of the PR2 register value as shown by Equation 27-4.

EQUATION 27-4: PWM RESOLUTION

$$\text{Resolution} = \frac{\log[4(\text{PR2} + 1)]}{\log(2)} \text{ bits}$$

Note: If the pulse width value is greater than the period the assigned PWM pin(s) will remain unchanged.

28.2.3 SPI MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK line. The master determines when the slave (Processor 2, Figure 28-5) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and Status bits appropriately set).

The clock polarity is selected by appropriately programming the CKP bit of the SSPCON1 register and the CKE bit of the SSPSTAT register. This then, would give waveforms for SPI communication as shown in Figure 28-6, Figure 28-8, Figure 28-9 and Figure 28-10, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- $F_{osc}/4$ (or T_{CY})
- $F_{osc}/16$ (or $4 * T_{CY}$)
- $F_{osc}/64$ (or $16 * T_{CY}$)
- Timer2 output/2
- $F_{osc}/(4 * (SSPADD + 1))$

Figure 28-6 shows the waveforms for Master mode.

When the CKE bit is set, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

Note: In Master mode the clock signal output to the SCK pin is also the clock signal input to the peripheral. The pin selected for output with the RxyPPS register must also be selected as the peripheral input with the SSPCLKPPS register.

28.3 I²C MODE OVERVIEW

The Inter-Integrated Circuit (I²C) bus is a multi-master serial data communication bus. Devices communicate in a master/slave environment where the master devices initiate the communication. A slave device is controlled through addressing.

The I²C bus specifies two signal connections:

- Serial Clock (SCL)
- Serial Data (SDA)

Figure 28-11 shows the block diagram of the MSSP module when operating in I²C mode.

Both the SCL and SDA connections are bidirectional open-drain lines, each requiring pull-up resistors for the supply voltage. Pulling the line to ground is considered a logical zero and letting the line float is considered a logical one.

Figure 28-11 shows a typical connection between two processors configured as master and slave devices.

The I²C bus can operate with one or more master devices and one or more slave devices.

There are four potential modes of operation for a given device:

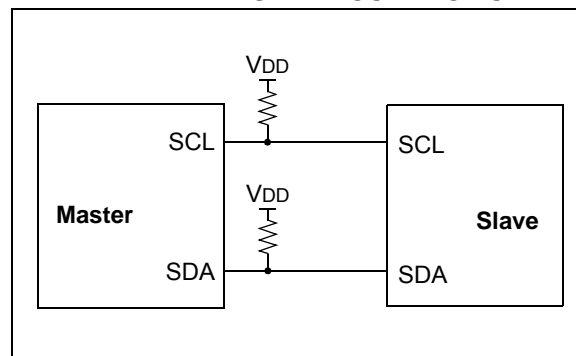
- Master Transmit mode
(master is transmitting data to a slave)
- Master Receive mode
(master is receiving data from a slave)
- Slave Transmit mode
(slave is transmitting data to a master)
- Slave Receive mode
(slave is receiving data from the master)

To begin communication, a master device starts out in Master Transmit mode. The master device sends out a Start bit followed by the address byte of the slave it intends to communicate with. This is followed by a single Read/Write bit, which determines whether the master intends to transmit to or receive data from the slave device.

If the requested slave exists on the bus, it will respond with an Acknowledge bit, otherwise known as an ACK. The master then continues in either Transmit mode or Receive mode and the slave continues in the complement, either in Receive mode or Transmit mode, respectively.

A Start bit is indicated by a high-to-low transition of the SDA line while the SCL line is held high. Address and data bytes are sent out, Most Significant bit (MSb) first. The Read/Write bit is sent out as a logical one when the master intends to read data from the slave, and is sent out as a logical zero when it intends to write data to the slave.

FIGURE 28-11: I²C MASTER/SLAVE CONNECTION



The Acknowledge bit ($\overline{\text{ACK}}$) is an active-low signal, which holds the SDA line low to indicate to the transmitter that the slave device has received the transmitted data and is ready to receive more.

The transition of a data bit is always performed while the SCL line is held low. Transitions that occur while the SCL line is held high are used to indicate Start and Stop bits.

If the master intends to write to the slave, then it repeatedly sends out a byte of data, with the slave responding after each byte with an $\overline{\text{ACK}}$ bit. In this example, the master device is in Master Transmit mode and the slave is in Slave Receive mode.

If the master intends to read from the slave, then it repeatedly receives a byte of data from the slave, and responds after each byte with an $\overline{\text{ACK}}$ bit. In this example, the master device is in Master Receive mode and the slave is Slave Transmit mode.

On the last byte of data communicated, the master device may end the transmission by sending a Stop bit. If the master device is in Receive mode, it sends the Stop bit in place of the last ACK bit. A Stop bit is indicated by a low-to-high transition of the SDA line while the SCL line is held high.

In some cases, the master may want to maintain control of the bus and re-initiate another transmission. If so, the master device may send another Start bit in place of the Stop bit or last $\overline{\text{ACK}}$ bit when it is in receive mode.

The I²C bus specifies three message protocols;

- Single message where a master writes data to a slave.
- Single message where a master reads data from a slave.
- Combined message where a master initiates a minimum of two writes, or two reads, or a combination of writes and reads, to one or more slaves.

29.2 Clock Accuracy with Asynchronous Operation

The factory calibrates the internal oscillator block output (INTOSC). However, the INTOSC frequency may drift as V_{DD} or temperature changes, and this directly affects the asynchronous baud rate. Two methods may be used to adjust the baud rate clock, but both require a reference clock source of some kind.

The first (preferred) method uses the OSCTUNE register to adjust the INTOSC output. Adjusting the value in the OSCTUNE register allows for fine resolution changes to the system clock source. See **Section 6.2.2.3 “Internal Oscillator Frequency Adjustment”** for more information.

The other method adjusts the value in the Baud Rate Generator. This can be done automatically with the Auto-Baud Detect feature (see **Section 29.4.1 “Auto-Baud Detect”**). There may not be fine enough resolution when adjusting the Baud Rate Generator to compensate for a gradual change in the peripheral clock frequency.

29.5.2.3 EUSART Synchronous Slave Reception

The operation of the Synchronous Master and Slave modes is identical (**Section 29.5.1.5 “Synchronous Master Reception”**), with the following exceptions:

- Sleep
- CREN bit is always set, therefore the receiver is never idle
- SREN bit, which is a “don’t care” in Slave mode

A character may be received while in Sleep mode by setting the CREN bit prior to entering Sleep. Once the word is received, the RSR register will transfer the data to the RCREG register. If the RCIE enable bit is set, the interrupt generated will wake the device from Sleep and execute the next instruction. If the GIE bit is also set, the program will branch to the interrupt vector.

29.5.2.4 Synchronous Slave Reception Set-up:

1. Set the SYNC and SPEN bits and clear the CSRC bit.
2. Clear the ANSEL bit for both the CK and DT pins (if applicable).
3. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
4. If 9-bit reception is desired, set the RX9 bit.
5. Set the CREN bit to enable reception.
6. The RCIF bit will be set when reception is complete. An interrupt will be generated if the RCIE bit was set.
7. If 9-bit mode is enabled, retrieve the Most Significant bit from the RX9D bit of the RCSTA register.
8. Retrieve the eight Least Significant bits from the receive FIFO by reading the RCREG register.
9. If an overrun error occurs, clear the error by either clearing the CREN bit of the RCSTA register or by clearing the SPEN bit which resets the EUSART.

TABLE 29-10: SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	—	—	—	ANSA4	—	ANSA2	ANSA1	ANSA0	122
ANSELB ⁽¹⁾	—	—	ANSB5	ANSB4	—	—	—	—	128
ANSELC	ANSC7 ⁽¹⁾	ANSC6 ⁽¹⁾	ANSC5 ⁽²⁾	ANSC4 ⁽²⁾	ANSC3	ANSC2	ANSC1	ANSC0	133
BAUD1CON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	336
CKPPS	—	—	—	CKPPS<4:0>					138, 139
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	85
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	86
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	89
RC1REG	EUSART Receive Data Register								329*
RC1STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	335
RXPPS	—	—	—	RXPPS<4:0>					138, 139
TRISA	—	—	TRISA5	TRISA4	— ⁽³⁾	TRISA2	TRISA1	TRISA0	121
TRISB ⁽¹⁾	TRISB7	TRISB6	TRISB5	TRISB4	—	—	—	—	127
TRISC	TRISC7 ⁽¹⁾	TRISC6 ⁽¹⁾	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISA0	132
TX1STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	334

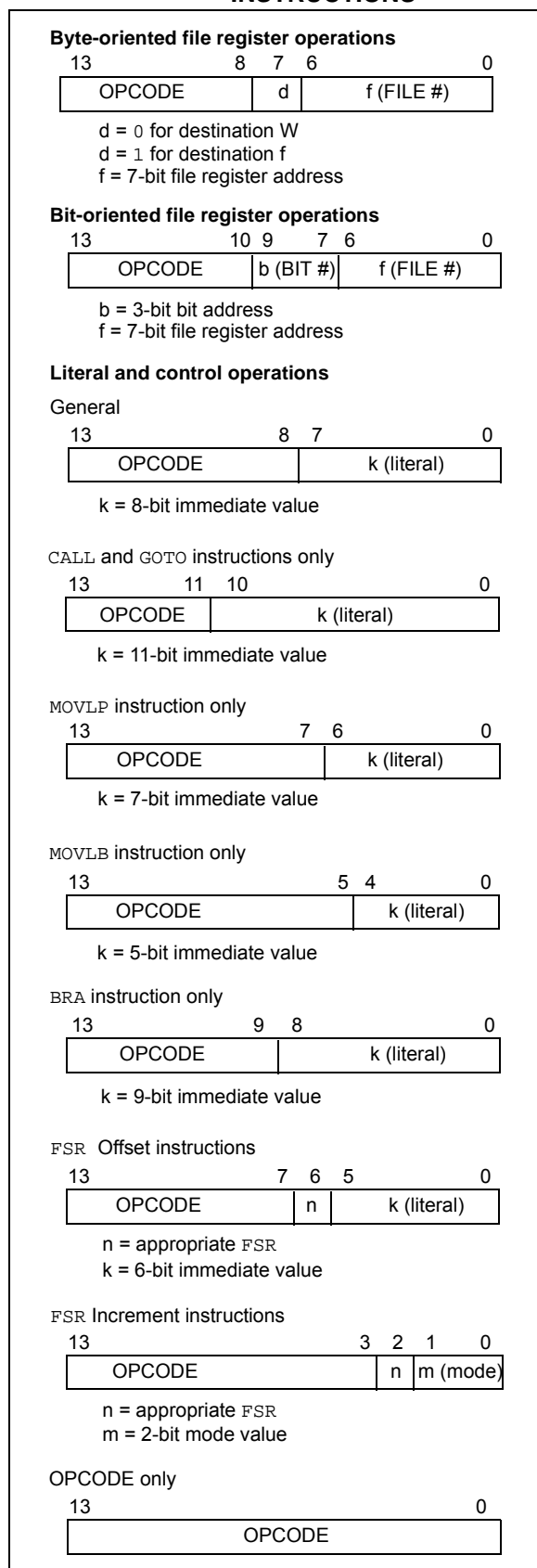
Legend: — = unimplemented location, read as ‘0’. Shaded cells are not used for synchronous slave reception.

* Page provides register information.

- Note**
- 1: PIC16(L)F1708 only.
 - 2: PIC16(L)F1704 only.
 - 3: Unimplemented, read as ‘1’.

PIC16(L)F1704/8

FIGURE 31-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16(L)F1704/8

RETFIE Return from Interrupt

Syntax: [*label*] RETFIE *k*

Operands: None

Operation: TOS → PC,
1 → GIE

Status Affected: None

Description: Return from Interrupt. Stack is POPed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a 2-cycle instruction.

Words: 1

Cycles: 2

Example:

```
RETFIE
After Interrupt
    PC = TOS
    GIE = 1
```

RETLW Return with literal in W

Syntax: [*label*] RETLW *k*

Operands: $0 \leq k \leq 255$

Operation: *k* → (W);
TOS → PC

Status Affected: None

Description: The W register is loaded with the 8-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a 2-cycle instruction.

Words: 1

Cycles: 2

Example:

```
CALL TABLE;W contains table
               ;offset value
    • ;W now has table value
    •
    •
    ADDWF PC ;W = offset
    RETLW k1 ;Begin table
    RETLW k2 ;
    •
    •
    •
    RETLW kn ; End of table
```

Before Instruction

W = 0x07

After Instruction

W = value of k8

RETURN Return from Subroutine

Syntax: [*label*] RETURN

Operands: None

Operation: TOS → PC

Status Affected: None

Description: Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a 2-cycle instruction.

RLF Rotate Left f through Carry

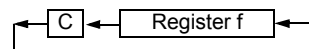
Syntax: [*label*] RLF *f*,*d*

Operands: $0 \leq f \leq 127$
d ∈ [0,1]

Operation: See description below

Status Affected: C

Description: The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is stored back in register 'f'.



Words: 1

Cycles: 1

Example:

```
RLF    REG1,0
```

Before Instruction

```
REG1    = 1110 0110
C        = 0
```

After Instruction

```
REG1    = 1110 0110
W        = 1100 1100
C        = 1
```

Note: Unless otherwise noted, $V_{IN} = 5V$, $F_{OSC} = 500\text{ kHz}$, $C_{IN} = 0.1\text{ }\mu\text{F}$, $T_A = 25^\circ\text{C}$.

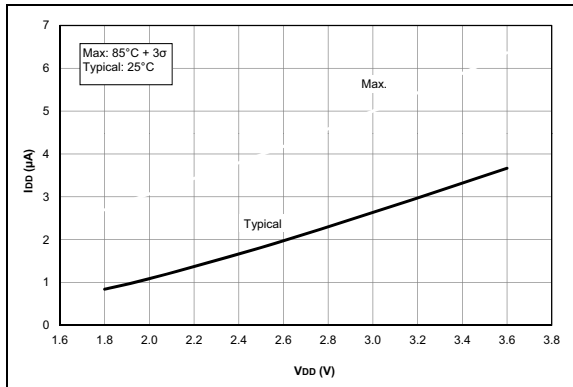


FIGURE 33-43: I_{PD} , Timer1 Oscillator, $F_{OSC} = 32\text{ kHz}$. PIC16LF1704/8 Only.

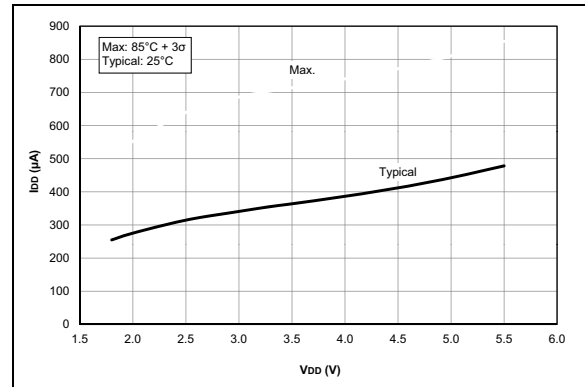


FIGURE 33-46: I_{PD} , Op Amp, High GBWP Mode ($OPAxSP = 1$). PIC16F1704/8 Only.

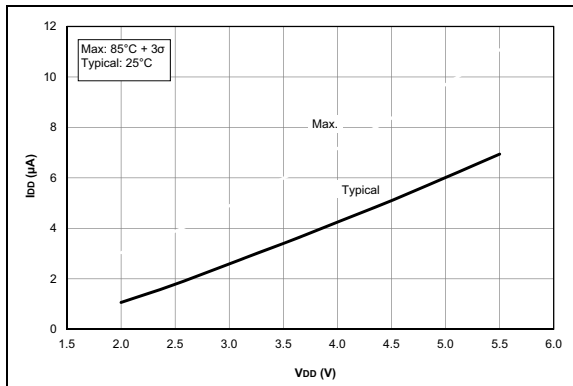


FIGURE 33-44: I_{PD} , Timer1 Oscillator, $F_{OSC} = 32\text{ kHz}$. PIC16F1704/8 Only.

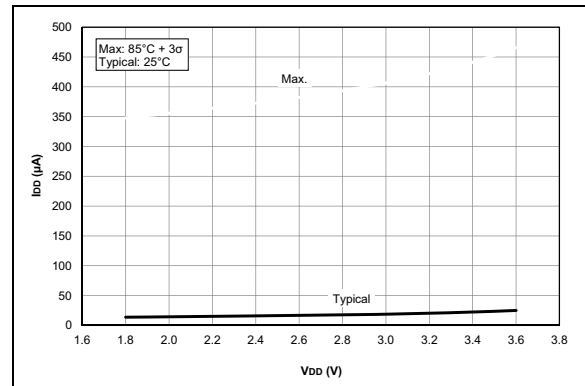


FIGURE 33-47: I_{PD} , ADC Non-Converting. PIC16LF1704/8 Only.

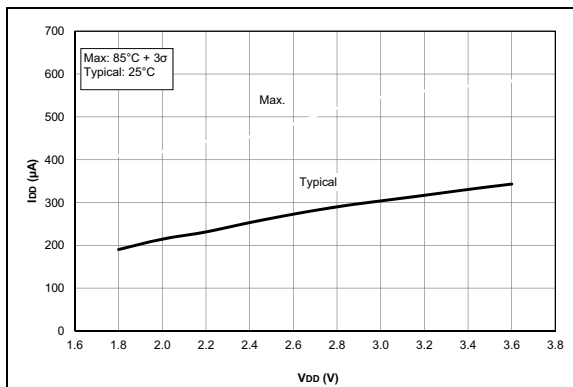


FIGURE 33-45: I_{PD} , Op Amp, High GBWP Mode ($OPAxSP = 1$). PIC16LF1704/8 Only.

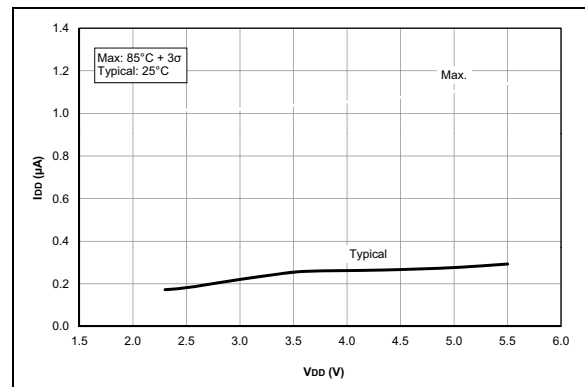


FIGURE 33-48: I_{PD} , ADC Non-Converting. PIC16F1704/8 Only.

Note: Unless otherwise noted, $V_{IN} = 5V$, $F_{OSC} = 500\text{ kHz}$, $C_{IN} = 0.1\text{ }\mu\text{F}$, $T_A = 25^\circ\text{C}$.

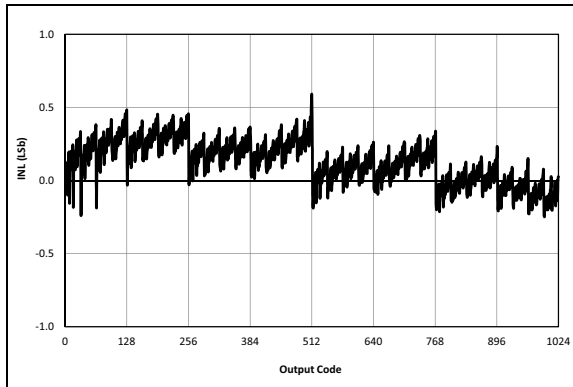


FIGURE 33-79: ADC 10-Bit Mode, Single-Ended INL, $V_{DD} = 3.0V$, $T_{AD} = 1\text{ }\mu\text{s}$, 25°C .

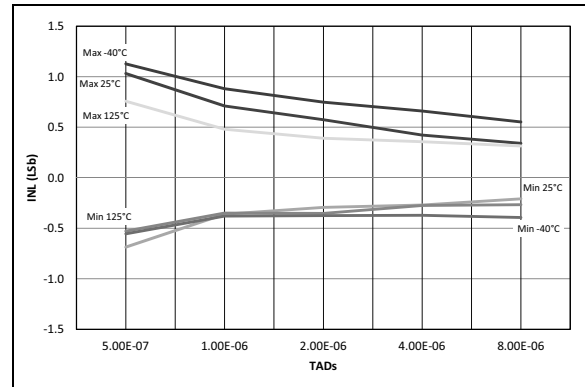


FIGURE 33-82: ADC 10-Bit Mode, Single-Ended INL, $V_{DD} = 3.0V$, $V_{REF} = 3.0V$.

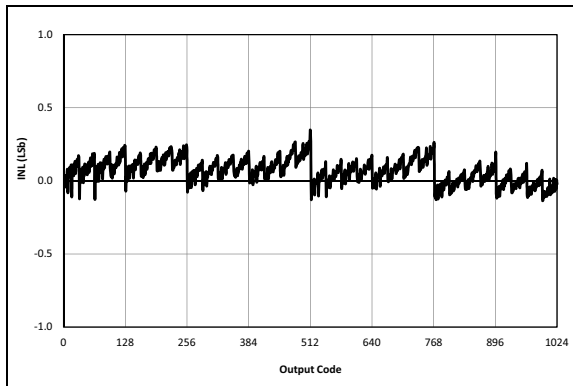


FIGURE 33-80: ADC 10-Bit Mode, Single-Ended INL, $V_{DD} = 3.0V$, $T_{AD} = 4\text{ }\mu\text{s}$, 25°C .

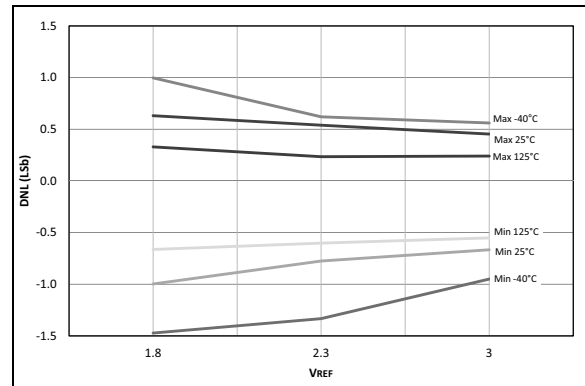


FIGURE 33-83: ADC 10-Bit Mode, Single-Ended DNL, $V_{DD} = 3.0V$, $T_{AD} = 1\text{ }\mu\text{s}$.

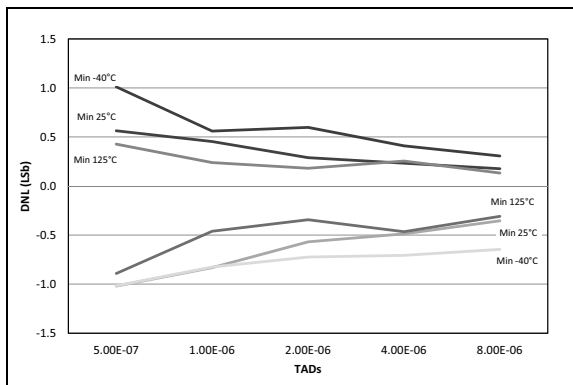


FIGURE 33-81: ADC 10-Bit Mode, Single-Ended DNL, $V_{DD} = 3.0V$, $V_{REF} = 3.0V$.

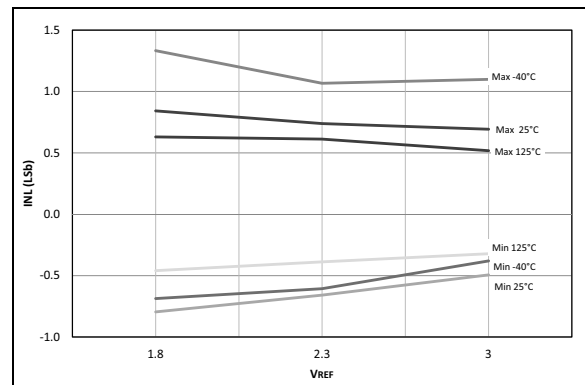
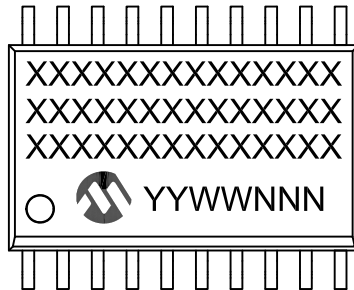


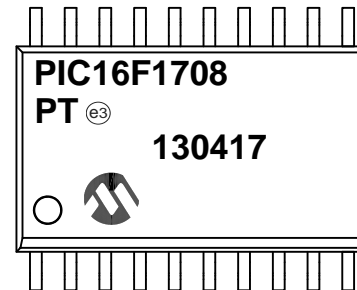
FIGURE 33-84: ADC 10-Bit Mode, Single-Ended INL, $V_{DD} = 3.0V$, $T_{AD} = 1\text{ }\mu\text{s}$.

Package Marking Information (Continued)

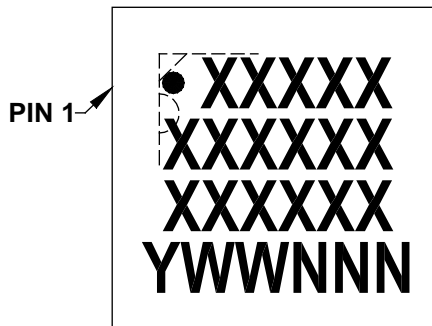
20-Lead SOIC (7.50 mm)



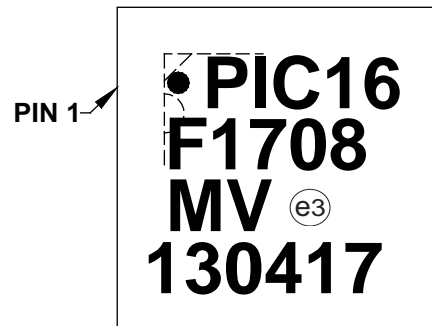
Example



20-Lead QFN (4x4x0.9 mm)



Example



Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC [®] designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC [®] designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.